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Recent Advances in Flexible Thermoelectric Films and Devices

Guest Editor:

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Deadline for manuscript submissions: closed (20 December 2022)

Message from the Guest Editor

Dear Colleagues,

This Special Issue of MDPI's Materials journal aims to provide a forum for academics and those in the industry to share their recent advances in the development of flexible thermoelectrics for - but not limited to - energy applications. Manuscripts dedicated to the research and development of flexible and thin-film thermoelectric materials, devices for power generation or cooling as well as metrological applications are welcome. Papers on the materials science of flexible and film thermoelectrics. practical implementation of these materials and devices on their basis, theoretical works, computational simulations of flexible TECs, methods for heat/electricity delivery to flexible thermoelectric converters (electrodes, interfaces. heat exchangers. thermoelectric etc.). processing and integration technologies, extending potential applications, economical aspects of the market of thermoelectrics, and review papers are also encouraged.

I look forward to your contributions.

Dr. Iurii Kogut Prof. Dr. Marie-Christine Record *Guest Editors*









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Message from the Editor-in-Chief

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